501787932 01/17/2012

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Atsushi OKAMOTO	09/29/2011
Hiroyuki HOSHI	09/29/2011
Setsuo ANDOU	09/29/2011

RECEIVING PARTY DATA

Name:	Hitachi Metals, Ltd.	
Street Address:	1-2-1, Shibaura, Minato-ku,	
City:	Tokyo	
State/Country:	JAPAN	
Postal Code:	105-8614	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13378174

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ATTORNEY DOCKET NUMBER:	110379
NAME OF SUBMITTER:	Mel R. Quintos

Total Attachments: 1

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PATENT REEL: 027541 FRAME: 0592 CH \$40.00 133

Kratz, Quintos & Hanson, LLP

U.S. ASSIGNMENT

(Insert ASSIGNEE's Name(s) Address(es))	IN CONSIDERATION of the sum of One Dollar (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter ASSIGNOR) by Hitachi Metals, Ltd. of 1-2-1, Shibaura, Minato-ku, Tokyo 105-8614 JAPAN (hereinafter ASSIGNEE), the receipt of which is hereby acknowledged, the undersigned ASSIGNOR hereby sells, assigns and transfers to ASSIGNEE the entire and exclusive right, title and interest to the invention entitled: METHOD FOR PRODUCING ALUMINUM FOIL				
(Title of Invention)					
(This of hivelinon)	METHOD FOR FRODUCING ALU	MINUM FOIL			
(*If the assignment is being filed after the filing of the application, this section must be completed)	for which application for Letters Patent of the United States was executed on even date herewi unless otherwise indicated below: December 14, 2011 * filed on, Serial No. 13/378,174 (Kratz, Quintos & Hanson, LLP is hereby authorized to insert the serial code, serial number and/				
	filing date hereon, when known)				
	and all Letters Patent of the United States to be obtained therefor on said application or any continuation, divisional, substitute, reissue or reexamination thereof for the full term or terms for which the same may be granted.				
	The ASSIGNOR agrees to execute all papers necessary in connection with the application and any continuation, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.				
	The ASSIGNOR agrees to execute all papers necessary in connection with any interference, litigation, or other legal proceeding which may be declared concerning this application or any continuation, divisional, reissue or reexamination thereof or Letters Patent or reissue patent issued thereon and to cooperate with the ASSIGNEE in every way possible in obtaining and producing evidence and proceeding with such interference, litigation, or other legal proceeding.				
	IN WITNESS WHEREOF, the unders	signed inventor(s) has (have) at	ffixed his/her/their signature(s).		
(Signatures)	X <u>Atsushī OKAMOTO</u> X	Atsushi OKAMOTO (Type Name)	× 29/9/2011 × (Date)		
	× Hiroguki HOSHI x	Hiroyuki HOSHI	× 29/9/2011 ×		
	(Signature)	(Type Name)	$\frac{\lambda - 277 + 72811}{\text{(Date)}} \times$		
	· Setono ANDO	Setsuo ANDOU	× 29/9/2011 ×		
	(Signature)	(Type Name)	(Date)		
	(Signature)	(Type Name)	(Date)		
	(Signature)	(Type Name)	(Date)		
	(Signature)	(Type Name)	(Date)		
NO LEGALIZATION	N REQUIRED		Re. 07/07		

PATENT REEL: 027541 FRAME: 0593

RECORDED: 01/17/2012